

P-Channel Enhancement Mode MOSFET

- **Features**

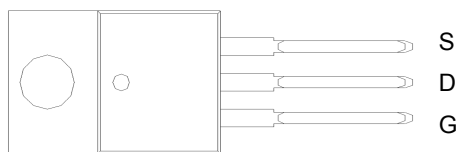
VDS	VGS	RDSon TYP	ID
-30V	±20V	15mR@-10V	-50A
		20mR@-4V5	

- **Applications**

- Load Switch
- DCDC conversion
- NB battery

- **Pin configuration**

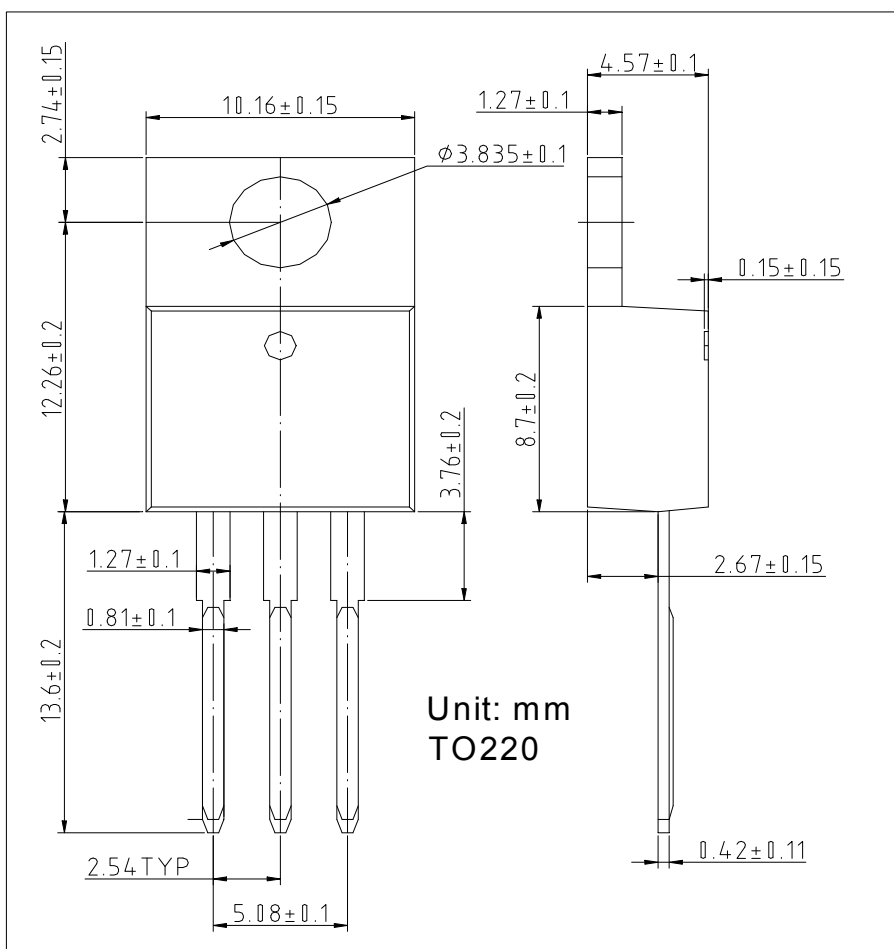
Top View



- **General Description**

This device is produced with high cell density, DMOS trench technology, which is especially used to minimize on-state resistance. This device is particularly suited for low voltage power management requiring a wide range of given voltage ratings (4.5V~25V) such as load switch and battery protection.

- **Package Information**





SSC8039GT4

● **Absolute Maximum Ratings** @ $T_A = 25^\circ\text{C}$ unless otherwise noted

Parameter		Symbol	Ratings	Unit
Drain-Source Voltage		V_{DSS}	-30	V
Gate-Source Voltage		V_{GSS}	± 20	V
Operating and Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$
Mounted on PCB of Minimum Footprint	Pulsed Drain Current (Note 2)	I_{DM}	100	A
	Continuous Drain Current (Note 1)	I_D	22	A
	Total Power Dissipation (Note 1)	P_D	24	W
Mounted on PCB of 1in ² Pad Area	Pulsed Drain Current (Note 2)	I_{DM}	100	A
	Continuous Drain Current (25 $^\circ\text{C}$)	I_D	35	A
	Total Power Dissipation (25 $^\circ\text{C}$)	P_D	50	W
Mounted on Large Heat Sink	Pulsed Drain Current (Note 2)	I_{DM}	100	A
	Continuous Drain Current (25 $^\circ\text{C}$) (Note 3)	I_D	50	A
	Total Power Dissipation (25 $^\circ\text{C}$)	P_D	70	W

● **Electrical Characteristics** @ $T_A = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = -250\mu\text{A}$	-30	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -30\text{ V}, V_{GS} = 0\text{ V}$	--	--	-1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	--	± 1.5	± 100	nA
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1	-1.3	-3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS} = -10\text{V}, I_D = -10\text{A}$	--	15	20	mR
		$V_{GS} = -4.5\text{V}, I_D = -7\text{A}$	--	20	35	
Forward Transconductance	G_{FS}	$V_{DS} = -5\text{ V}, I_D = -10\text{ A}$	--	18	--	S
Input Capacitance	C_{ISS}	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V},$ $f = 1\text{MHz}$	--	2000	--	pF
Output Capacitance	C_{OSS}		--	550	--	
Reverse Transfer Capacitance	C_{RSS}		--	800	--	
Turn-On Delay Time	$T_{D(ON)}$	$V_{GS} = -10\text{V}, V_{DS} = -15\text{V},$ $R_L = 1.5\text{R}, R_{GEN} = 3\text{R}$	--	8.6	--	nS
Turn-Off Delay Time	$T_{D(OFF)}$		--	39	--	
Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{ V}, I_S = -1\text{ A}$	--	-0.75	-1.2	V

NOTES:

1. DUT is mounted on a 1in² FR-4 board with 2oz. Copper in a still air environment at 25 $^\circ\text{C}$, the current rating is based on the DC (<10s) test conditions.
2. Repetitive rating, pulse width limited by junction temperature. 300us Pulse Drain Current Tested.
3. Current limited by bond wire.

● **Typical Performance Characteristics**

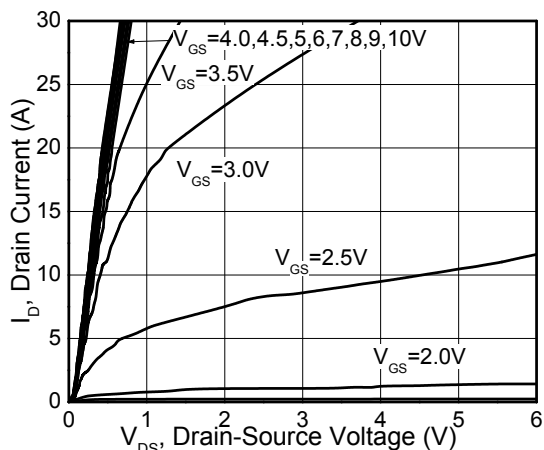


Fig1. Drain current vs Drain voltage

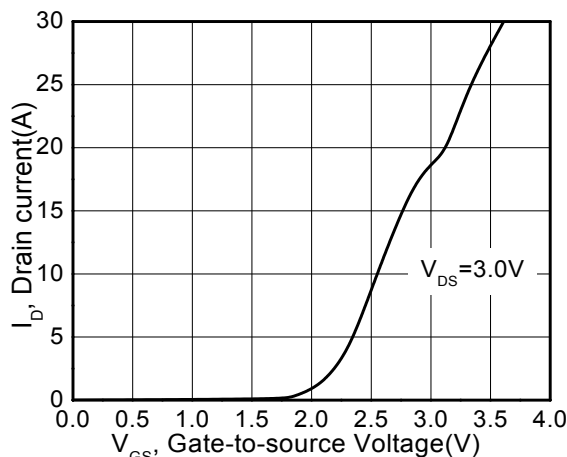


Fig2. Transfer Characteristics

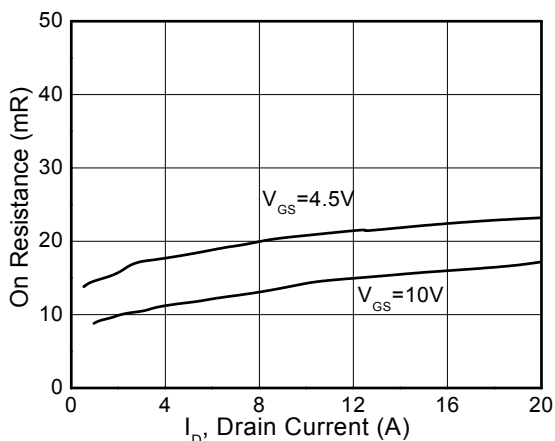


Fig3. On-resistance vs. I_D

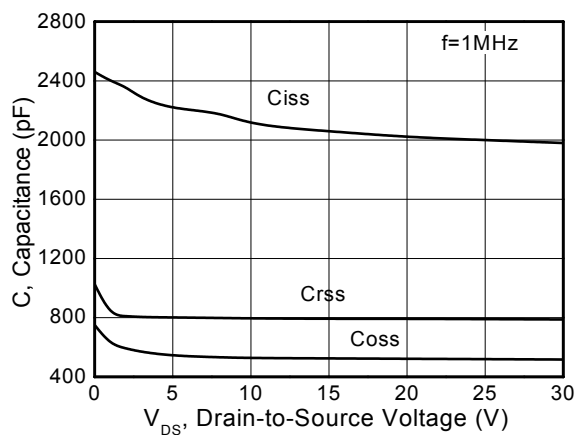


Fig4. Capacitance vs. V_{DS}

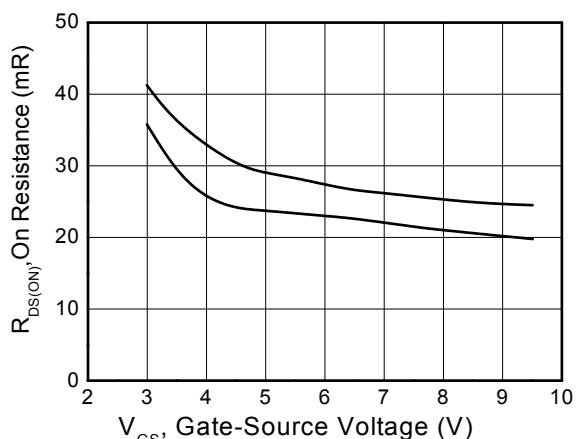


Fig5. On-resistance vs. Gate-Source Voltage

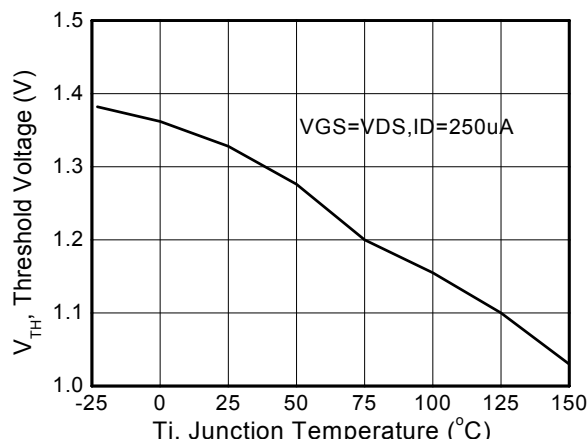


Figure6. Threshold vs Temperature



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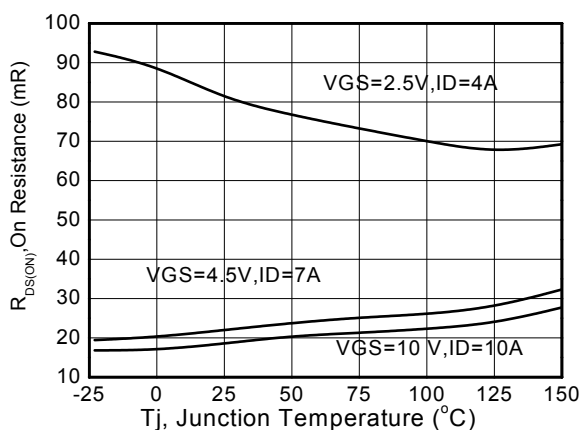


Fig7. On-resistance vs. Temperature

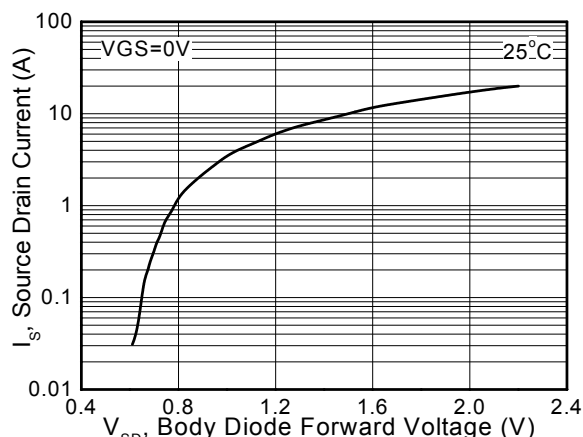


Fig8. Source Drain Current vs. V_{SD}



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